Docket No.:

DECLA	<u>RATION AND PC</u>	WER OF AT	TORNEY
As a below named inventor, I hereby declar	e that:		
My residence, post office and citizenship and	e as stated below next to my	name,	
I believe I am the original, first and sole in inventor (if plural names are listed below) invention entitled <u>PLASMA DISPLAY PANEL</u> ,	of the subject matter claim	s listed below) or an ed and for which a	original, first and joint patent is sought on the
[] is attached hereto [] was filed o	onas Applicat	ion Serial <u>No</u>	and was
amended on	(if applicab	le)	· ·a
I hereby state that I have reviewed and und claims, as amended by any amendment references		above-identified spe	ecification, including the
I acknowledge the duty to disclose informa with Title 37, Code of Federal Regulations,		to be material to pat	entability in accordance
I hereby claim foreign priority benefits under or inventor's certificate, or 365(a) of any PC than the United States of America, listed be application for patent or inventor's certificate that of the application on which priority is c	T international application w low and have also identified te, or of any PCT internation	which designated at le below, by checking t	ast one country other he box, any foreign
Prior Foreign Application(s): Number	Country		gn Filing Date th/Day/Year
10-2003-0018451	KOREA	03/25/	2003
10-2003-0018452	KOREA	. 03/25/	2003
10-2003-0035338	KOREA	06/02/	2003
I hereby claim the benefit under 35 U.S.C. 1	19(e) of any United States p.	rovisional application	n(s) listed below.
Application Number(s):	Filing Date (Month/Day/Year)		
I hereby claim the benefit under 35 U.S. international application designating the Un each of the claims of this application is not the manner provided by the first paragraph is material to patentability as defined in 37 application and the national or PCT internat	ited States of America, listed disclosed in the prior Unite of 35 U.S.C. 112, I acknowl CFR 1.56 which became a	d below and, insofared States or PCT inte edge the duty to disc vailable between the	as the subject matter of rnational application in close information which
Prior U. S. Application or PCT Parent Number Filing I	Date (Month/Day/Year)	Parent Patent No	umber (if applicable)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Ð

I hereby appoint the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. <u>Direct all correspondence to Customer Number 34610</u>.

Full name of sole or first inventor: Jungwon KANG		
Inventor's signature:	Date:	02/20/20x
Mailing Address: Hangaram Apt. 212-1503, Ichon 1-dong, Yongsan-gu, Seoul, Korea		
Citizenship: Republic of Korea		
Residence Address		
(only if different from mailing address):		
**************************************	*****	*******
Full name of joint inventor(s): Woong Kee, MIN		
Inventor's signature: ルゼア	Date:	03/20/2004
Mailing Address: Samin-ri 286, Byeongyeong-myeon, Kangjin-gun, Jeollanam-do, Kore	ea	<u> </u>
Citizenship: Republic of Korea		
Residence Address		
(only if different from mailing address):		
**************************************	********	*******
Full name of joint inventor(s):		
Inventor's signature:	Date:	
Mailing Address:		
Citizenship:		
Residence Address		
(only if different from mailing address):		
**************************************	*******	******
Full name of joint inventor(s):		
Inventor's signature:	Date:	
Mailing Address:		
Citizenship:		
Residence Address		
(only if different from mailing address):		
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Full name of joint inventor(s):		
Inventor's signature:	Date:	
Mailing Address:		
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Residence Address		
(only if different from mailing address):		
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Full name of joint inventor(s):		
Inventor's signature:	Date:	
Mailing Address:		
Citizenship:		
Residence Address		
(only if different from mailing address):		